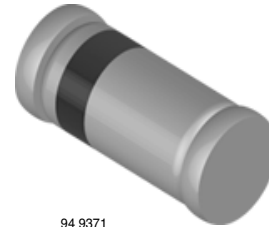


## Small Signal Fast Switching Diodes

### Features

- Silicon Epitaxial Planar Diodes
- Electrical data identical with the devices 1N4148 and 1N4448 respectively
- Lead (Pb)-free component
- Component in acc. to RoHS 2002/95/EC and WEEE 2002/96/EC



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### Applications

- Extreme fast switches

### Mechanical Data

**Case:** MiniMELF Glass case (SOD80)

**Weight:** approx. 31 mg

**Cathode Band Color:** Black

**Packaging Codes/Options:**

GS18 / 10 k per 13" reel (8 mm tape), 10 k/box

GS08 / 2.5 k per 7" reel (8 mm tape), 12.5 k/box

### Parts Table

Part	Type differentiation	Ordering code	Remarks
LL4148	$V_{RRM} = 100\text{ V}$ , $V_F = \text{max. } 1000\text{ mV}$ at $I_F = 50\text{ mA}$	LL4148-GS18 or LL4148-GS08	Tape and Reel
LL4448	$V_{RRM} = 100\text{ V}$ , $V_F = \text{max. } 1000\text{ mV}$ at $I_F = 100\text{ mA}$	LL4448-GS18 or LL4448-GS08	Tape and Reel

### Absolute Maximum Ratings

$T_{amb} = 25\text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Repetitive peak reverse voltage		$V_{RRM}$	100	V
Reverse voltage		$V_R$	75	V
Peak forward surge current	$t_p = 1\text{ }\mu\text{s}$	$I_{FSM}$	2	A
Repetitive peak forward current		$I_{FRM}$	500	mA
Forward continuous current		$I_F$	300	mA
Average forward current	$V_R = 0$	$I_{FAV}$	150	mA
Power dissipation		$P_V$	500	mW

### Thermal Characteristics

$T_{amb} = 25\text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Junction to ambient air	on PC board 50 mm x 50 mm x 1.6 mm	$R_{thJA}$	500	K/W
Junction temperature		$T_j$	175	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	- 65 to + 175	$^\circ\text{C}$

### Electrical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Part	Symbol	Min	Typ.	Max	Unit
Forward voltage	$I_F = 5\text{ mA}$	LL4448	$V_F$	620		720	mV
	$I_F = 50\text{ mA}$	LL4148	$V_F$		860	1000	mV
	$I_F = 100\text{ mA}$	LL4448	$V_F$		930	1000	mV
Reverse current	$V_R = 20\text{ V}$		$I_R$			25	nA
	$V_R = 20\text{ V}, T_j = 150\text{ }^{\circ}\text{C}$		$I_R$			50	$\mu\text{A}$
	$V_R = 75\text{ V}$		$I_R$			5	$\mu\text{A}$
Breakdown voltage	$I_R = 100\text{ }\mu\text{A}, t_p/T = 0.01,$ $t_p = 0.3\text{ ms}$		$V_{(BR)}$	100			V
Diode capacitance	$V_R = 0, f = 1\text{ MHz}, V_{HF} = 50\text{ mV}$		$C_D$			4	pF
Rectification efficiency	$V_{HF} = 2\text{ V}, f = 100\text{ MHz}$		$\eta_r$	45			%
Reverse recovery time	$I_F = I_R = 10\text{ mA},$ $i_R = 1\text{ mA}$		$t_{rr}$			8	ns
	$I_F = 10\text{ mA}, V_R = 6\text{ V},$ $i_R = 0.1 \times I_R, R_L = 100\text{ }\Omega$		$t_{rr}$			4	ns

### Typical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

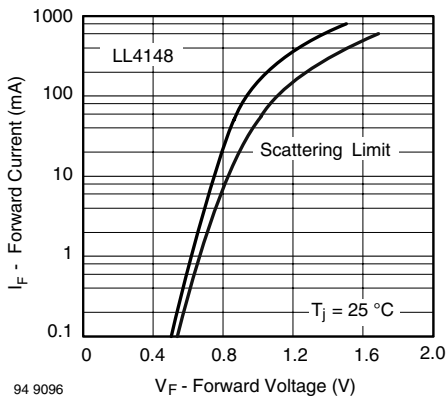


Figure 1. Forward Current vs. Forward Voltage

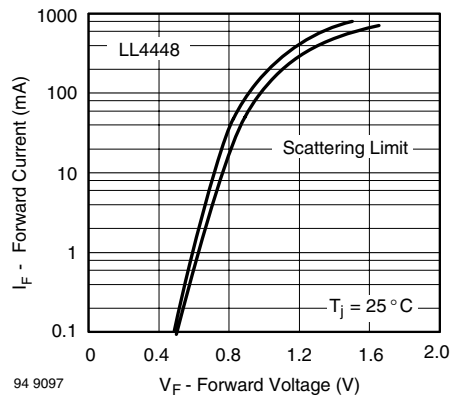
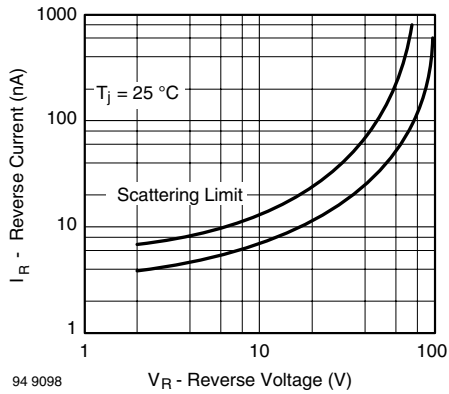
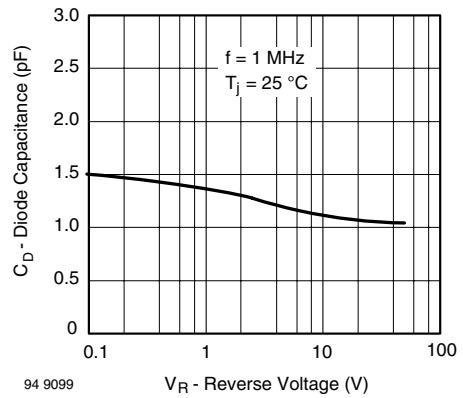


Figure 2. Forward Current vs. Forward Voltage



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Figure 3. Reverse Current vs. Reverse Voltage



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Figure 4. Diode Capacitance vs. Reverse Voltage

## Package Dimensions in mm (Inches)

